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TITLE:  NI-360 HIGH FREQUENCY	DOCUMENT NO: 98ARH99181A	REV: D
	STANDARD: NON-JEDEC	
	SOT1814-1	22 MAR 2016



NOTES:

1. CONTROLLING DIMENSION: INCH
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
3. DIMENSION H IS MEASURED .030 (0.762) AWAY FROM PACKAGE BODY

STYLE 1:

- PIN 1 - GATE
- 2 - DRAIN
- 3 - SOURCE

DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	.795	.805	20.19	20.45	N	.355	.365	9.96	10.16
B	.225	.235	5.72	5.97	Q	.125	.135	3.18	3.43
C	.125	.176	3.18	4.47	R	.225	.235	5.72	5.97
D	.034	.044	0.89	1.12	S	.225	.235	5.72	5.97
E	.055	.065	1.40	1.65					
F	.004	.006	0.10	0.15	aaa	.005		0.13	
G	.562 BSC		14.28 BSC		bbb	.010		0.25	
H	.077	.087	1.96	2.21	ccc	.015		0.38	
K	.085	.115	2.16	2.92					
M	.355	.365	9.02	9.27					

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